UNITED STATES ENVIRONMENTAL PROTECTION AGENCY
REGION 2
290 BROADWAY
NEW YORK, NY 10007-1866

November 15, 2013

VIA EMAIL (jmcgahren@morganlewis.com) And FIRST CLASS MAIL

Mr. John McGahren
Morgan, Lewis & Bockius LLP
502 Carnegie Center
Princeton, NJ 08540

Re: FOIA EPA-R2-2014-000590
Maywood Chemical Company Superfund Site, Maywood, New Jersey

Dear Mr. McGahren:

The U.S. Environmental Protection Agency (EPA) Region 2 Freedom of Information Officer received your October 2, 2013 letter, in which you request documents relating to the remedial action being implemented by the U.S. Army Corps of Engineers ("USACE") at the Maywood Chemical Company Superfund Site ("Site") at portions of the Site identified in the Maywood Chemical Company Superfund Site August 2013 Proposed Plan. The request has been assigned a tracking number: EPA-R2-2014-000590.

We have one document, a Post Remedial Action Report for 23 West Howcroft Road, Block 124, Lot 17, Maywood, New Jersey – May 2011, in our records that would meet your information request specifications for the DeSaussure property. The USACE provided this information to you via an October 17, 2013 FOIA response and therefore we will not be duplicating this document and transmitting it to you.

The USACE is responsible for the FUSRAP contamination at the three properties noted in your request. FUSRAP remedial action work is underway at the Sears and Stepan properties and is not complete. The USACE provides Post Remedial Action Reports to EPA following the completion of the remedial action work and we do not have documents that you are requesting for these properties where work is ongoing. We have been informed by USACE that excavation and waste characterization information was provided to you on October 17th, 30th and November 15th in response to FOIA and follow-up information requests made on Stepan's behalf.

The EPA has no other information in response to your request, which EPA now considers completed.

Sincerely,

Betsy Donovan
Project Manager

cc: W. Calderon, L. DeMarco, S. Cohen (via email)